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January 2003

# **FDG6318PZ**

SEMICONDUCTOR

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# **Dual P-Channel, Digital FET**

## **General Description**

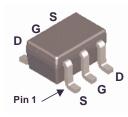
These dual P-Channel logic level enhancement mode MOSFET are produced using Fairchild Semiconductor's especially tailored to minimize on-state resistance. This device has been designed especially for bipolar digital transistors and small signal MOSFETS

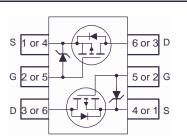
# **Applications**

· Battery management

# Features

- -0.5A, -20V.  $r_{DS(ON)} = 780 m\Omega (Max) @ V_{GS} = -4.5 V$  $r_{DS(ON)} = 1200 m\Omega$  (Max) @  $V_{GS} = -2.5 V$
- · Very low level gate drive requirements allowing direct operation in 3V circuits ( $V_{GS(TH)} < 1.5V$ ).
- Gate-Source Zener for ESD ruggedness (>1.4kV Human Body Model).
- · Compact industry standard SC-70-6 surface mount package.





SC70-6 The pinouts are symmetrical; pin1 and pin 4 are interchangeable.

**MOSFET Maximum Ratings** T<sub>A</sub>=25°C unless otherwise noted

Symbol	Parameter	Ratings	Units
V <sub>DSS</sub>	Drain to Source Voltage	-20	V
V <sub>GS</sub>	Gate to Source Voltage	±12	V
	Drain Current		
	Continuous (T <sub>C</sub> = $25^{\circ}$ C, V <sub>GS</sub> = - 4.5V)	-0.5	A
I <sub>D</sub>	Continuous (T <sub>C</sub> = $100^{\circ}$ C, V <sub>GS</sub> = - 2.5V)	-0.3	A
	Pulsed	Figure 4	
P <sub>D</sub>	Power dissipation	0.3	W
·D	Derate above 25°C	2.4	mW/ºC
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature	-55 to 150	°C
ESD	Electrostatic Discharge Rating MIL-STD-883D Human Body Model (100pF / 1500Ω)	1.4	kV
Therma	Characteristics		
R <sub>θJA</sub>	Thermal Resistance Junction to Ambient (Note 1)	415	°C/W

$R_{ extsf{ heta}JA}$	Thermal Resistance Junction to Ambient (Note 1)	415	°C/

# **Package Marking and Ordering Information**

Package	Reel Size	Tape Width	Quantity
Z SC70-6	7"	8 mm	3000
	v		

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Symbol	Parameter	Test Conditions		Min	Тур	Max	Units
Off Cha	racteristics						
B <sub>VDSS</sub>	Drain to Source Breakdown Voltage	$I_{D} = -250 \mu A, V_{GS} = 0$	I <sub>D</sub> = -250μA, V <sub>GS</sub> = 0V		-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>GS</sub> =-16V, V <sub>GS</sub> =0	$V_{GS} = -16V, V_{GS} = 0V$		-	-3	μΑ
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 12V$ , $V_{GS} =$	$V_{GS} = \pm 12V$ , $V_{GS} = 0V$		-	±10	μΑ
On Cha	racteristics						
V <sub>GS(TH)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = -25$	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = -250μA		-0.9	-1.5	V
r <sub>DS(ON)</sub>	Drain to Source On Resistance	I <sub>D</sub> = -0.5A, V <sub>GS</sub> = -4	I <sub>D</sub> = -0.5A, V <sub>GS</sub> = -4.5V		580	780	mΩ
D3(0N)	Drain to Source On Resistance	$I_D = -0.4A, V_{GS} = -2$	I <sub>D</sub> = -0.4A, V <sub>GS</sub> = -2.5V		910	1200	
Dynami	ic Characteristics						
C <sub>ISS</sub>	Input Capacitance	101/11/	$V_{DS} = -10V, V_{GS} = 0V,$ f = 1MHz		85.4	-	pF
C <sub>OSS</sub>	Output Capacitance	50 . 00			24.9	-	pF
C <sub>RSS</sub>	Reverse Transfer Capacitance				8.83	-	pF
Q <sub>g(TOT)</sub>	Total Gate Charge at -4.5V	$V_{GS} = 0V$ to -4.5V	$V_{DD} = 0V t_{0} - 2.5V$ $V_{DD} = -10V$		1.08	1.62	nC
Q <sub>g(-2.5)</sub>	Total Gate Charge at -2.5V	$V_{GS} = 0V$ to -2.5V			0.67	1.0	nC
Q <sub>gs</sub>	Gate to Source Gate Charge		I <sub>D</sub> = -0.5A I <sub>a</sub> = 1.0mA	-	0.21	-	nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge		1g = 1.0117 (		0.33	-	nC
Switchi	ng Characteristics (V <sub>GS</sub> = -4.5V	)					
t <sub>ON</sub>	Turn-On Time				-	35	ns
tuan	Turn-On Delay Time	V <sub>DD</sub> = -10V, I <sub>D</sub> = -0.5A		-	10	-	ns
t <sub>d(ON)</sub>	,						
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = -10V, I <sub>D</sub> = -0.5	5A	-	13	-	ns

### **Drain-Source Diode Characteristics**

Fall Time

Turn-Off Time

V <sub>SD</sub>	Source to Drain Diode Voltage	I <sub>SD</sub> = -0.5A	-	-0.9	-1.2	V
t <sub>rr</sub>	Reverse Recovery Time	$I_{SD}$ = -0.5A, d $I_{SD}$ /dt = 100A/µs	-	-	22	ns
Q <sub>RR</sub>	Reverse Recovered Charge	$I_{SD}$ = -0.5A, $dI_{SD}/dt$ = 100A/µs	-	-	16	nC

Notes:

t<sub>f</sub>

 $t_{\mathsf{OFF}}$ 

 R<sub>6JA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the center drain pad. R<sub>6JC</sub> is guaranteed by design while R<sub>6CA</sub> is determined by user's board design. R<sub>6JA</sub> = 415 °C/W when mounted on a 1inch<sup>2</sup> copper pad.

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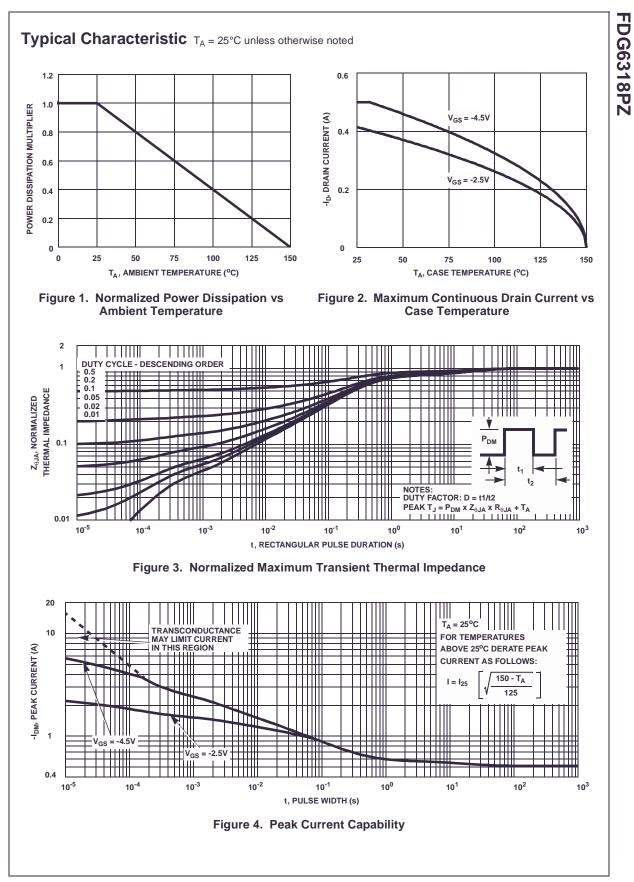
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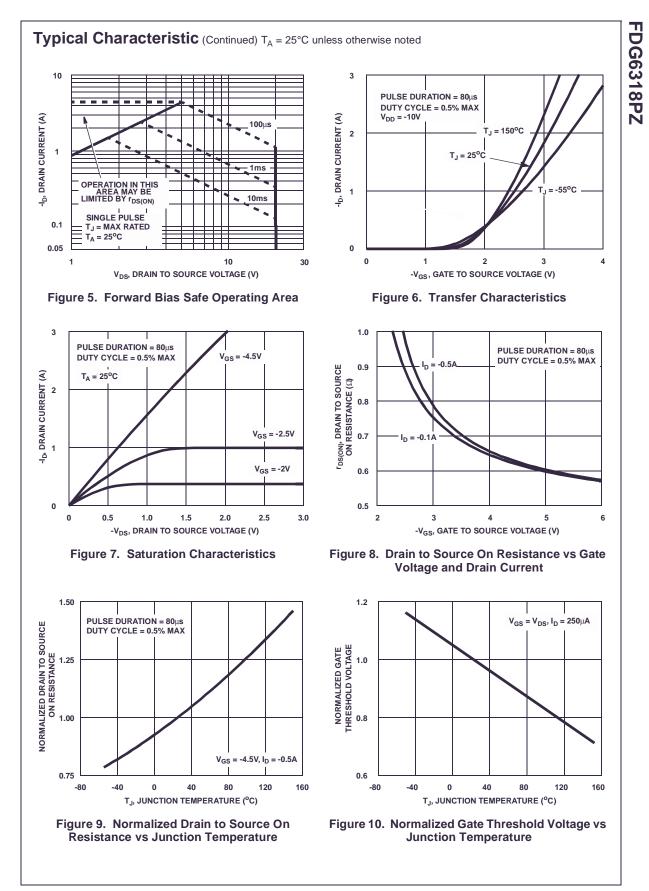
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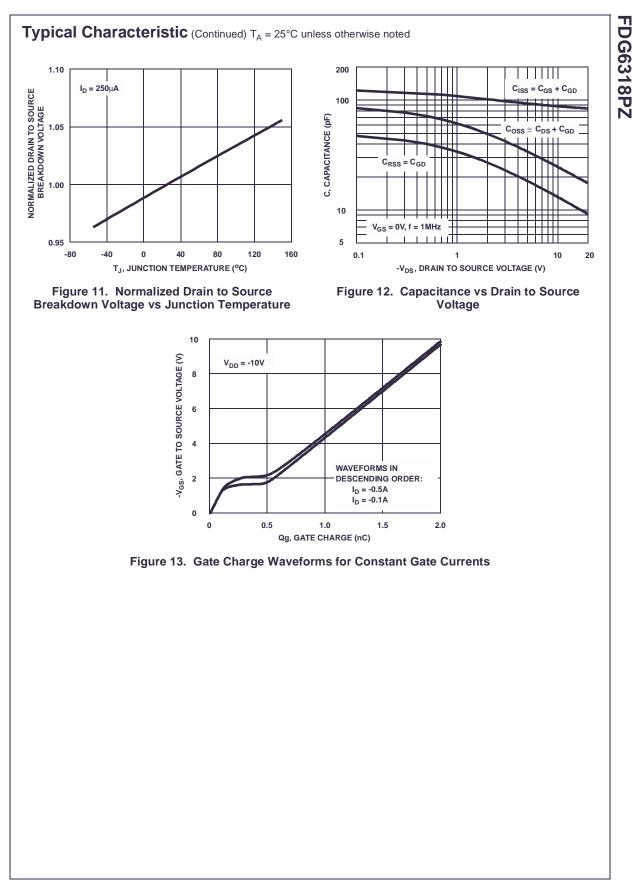


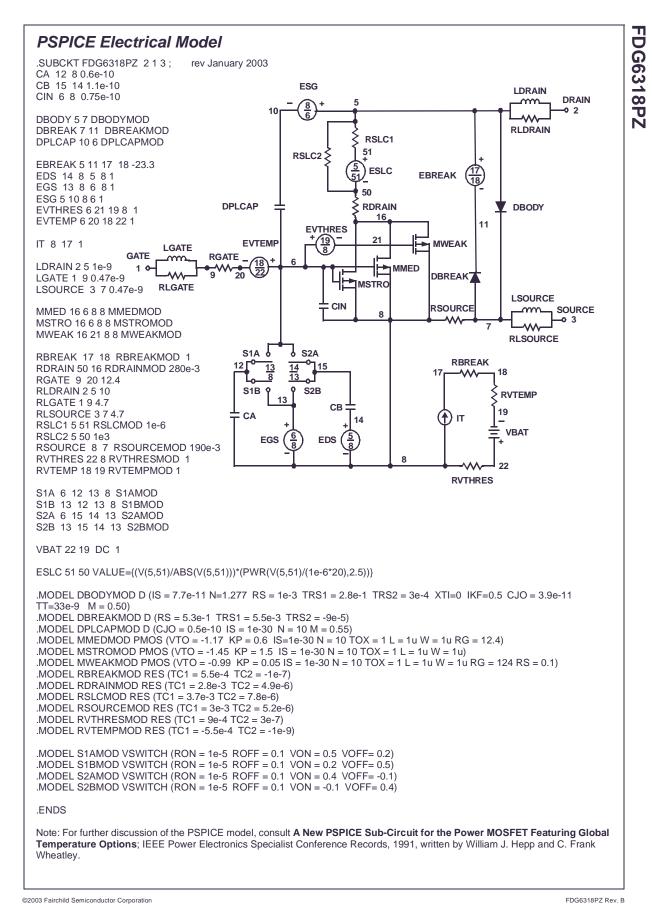
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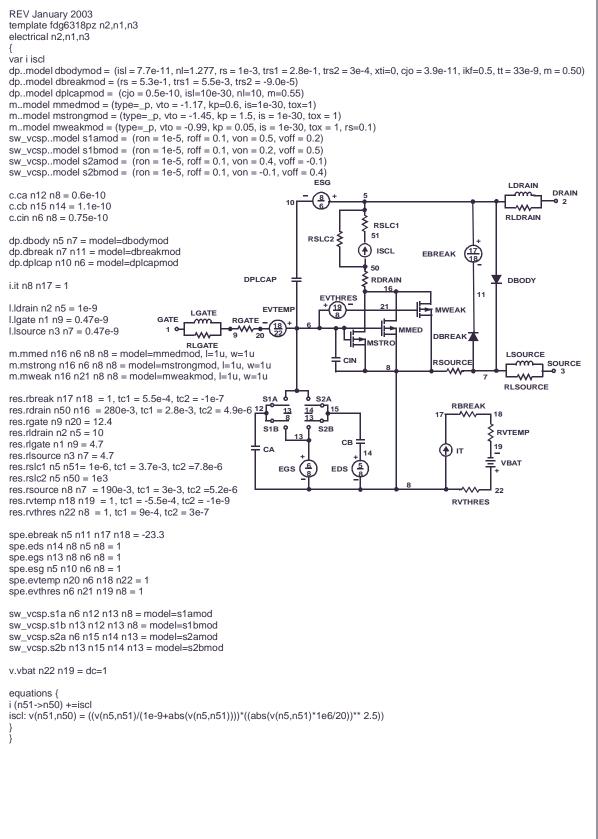
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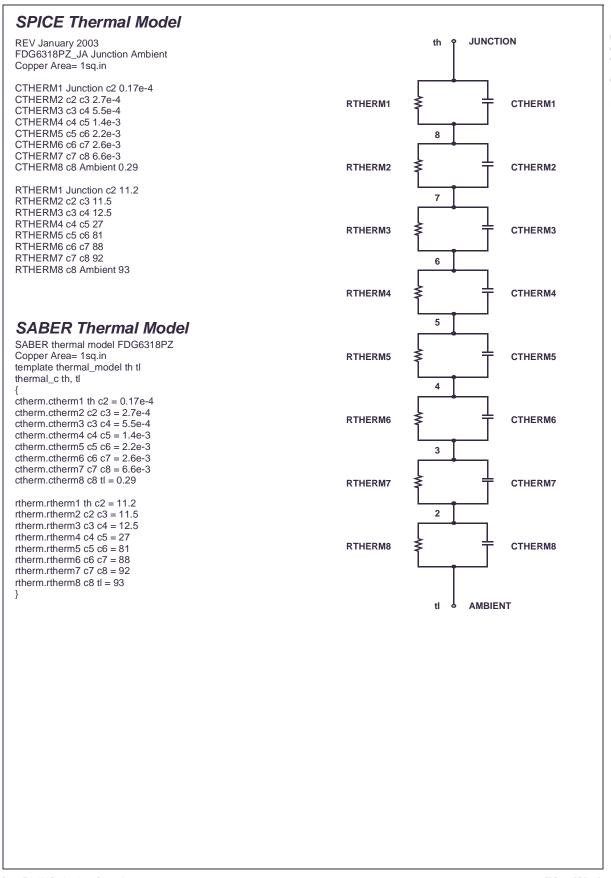
# SABER Electrical Model



FDG6318PZ Rev. B

# FDG6318PZ

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